

MOSFET - N-Channel, POWERTRENCH®

150 V, 29 A, 54 m Ω

FDP2572

Features

- $R_{DS(on)} = 45 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 9 \text{ A}$
- $Q_{G(tot)} = 26 \text{ nC (Typ.)} @ V_{GS} = 10 \text{ V}$
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)
- This Device is Pb-Free and Halide Free

Applications

- Consumer Appliances
- Synchronous Rectification
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter

MOSFET MAXIMUM RATINGS (T_C = 25°C, unless otherwise noted)

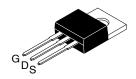
Symbol		Parameter	Value	Unit
V_{DSS}	Drain to Source	Voltage	150	V
V_{GS}	Gate to Source	Voltage	±20	V
I _D	Drain Current	Continuous $(T_C = 25^{\circ}C, V_{GS} = 10 \text{ V})$	29	Α
		Continuous (T _C = 100°C, V _{GS} = 10 V)	20	Α
		Continuous $(T_{amb} = 25$ °C, $V_{GS} = 10$ V, $R_{\theta JA} = 43$ °C/W)	4	A
		Pulsed	Figure 4	Α
E _{AS}	Single Pulse Avalanche Energy (Note 1)		36	mJ
P _D	Power Dissipation		135	W
	Derate above 25	5°C	0.9	W/°C
T _J , T _{STG}	Operating and S	Storage Temperature	–55 to 175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R _θ JC	Thermal Resistance, Junction to Case, Max.	1.11	°C/W
R _θ JA	Thermal Resistance, Junction to Ambient, Max. (Note 2)	62.5	°C/W

V _{DS}	R _{DS(on)} MAX	I _D MAX
150 V	54 mΩ @ 10 V	29 A



TO-220-3LD CASE 340AT

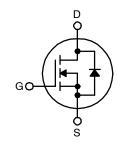
MARKING DIAGRAM

&Z&3&K FDP2572

&Z = Assembly Plant Code &3 = 3-Digit Date Code

&K = 2-Digits Lot Run Traceability Code

FDP2572 = Specific Device Code



N-Channel

ORDERING INFORMATION

Device	Package	Shipping
FDP2572	TO-220-3LD	800 Units / Tube

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	•	•	-	-	-
B _{VDSS}	Drain to Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	150	_	_	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V, V _{DS} = 120 V	-	-	1	μΑ
		V _{GS} = 0 V, V _{DS} = 120 V, T _C = 150°C	-	-	250	1
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V	-	-	±100	nA
ON CHARA	CTERISTICS	•	•		•	•
V _{GS(TH)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2	-	4	V
R _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10 V, I _D = 9 A	-	0.045	0.054	Ω
		V _{GS} = 6 V, I _D = 4 A	_	0.050	0.075	1
		V _{GS} = 10 V, I _D = 9 A, T _C = 175°C	_	0.126	0.146	1
DYNAMIC C	CHARACTERISTICS					
C _{ISS}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	1770	_	pF
Coss	Output Capacitance		_	183	-	pF
C _{RSS}	Reverse Transfer Capacitance		_	40	-	pF
Q _{g(TOT)}	Total Gate Charge at 10 V	$V_{DD} = 75 \text{ V}, I_D = 9 \text{ A}, I_g = 1.0 \text{ mA}, V_{GS} = 0 \text{ V to } 10 \text{ V}$	-	26	34	nC
Q _{g(TH)}	Threshold Gate Charge	V _{DD} = 75 V, I _D = 9 A, I _g = 1.0 mA, V _{GS} = 0 V to 2 V	-	3.3	4.3	nC
Q _{gs}	Gate to Source Gate Charge	V _{DD} = 75 V, I _D = 9 A, I _g = 1.0 mA	-	8	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau		-	5	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	6	-	nC
RESISTIVE	SWITCHING CHARACTERISTICS (V _G	S = 10 V)	•			
t _{ON}	Turn-On Time	$V_{DD} = 75 \text{ V}, I_D = 9 \text{ A}, V_{GS} = 10 \text{ V},$	-	-	36	ns
t _{d(ON)}	Turn-On Delay Time	$R_{GS} = 11.0 \Omega$	-	11	-	ns
t _r	Rise Time		_	14	-	ns
t _{d(OFF)}	Turn-Off Delay Time		-	31	-	ns
t _f	Fall Time		-	14	-	ns
t _{OFF}	Turn-Off Time		_	-	66	ns
DRAIN-SOL	JRCE DIODE CHARACTERISTICS	•				
V _{SD}	Source to Drain Diode Voltage	I _{SD} = 9 A	-	_	1.25	V
		I _{SD} = 4 A	-	-	1.0	V
t _{rr}	Reverse Recovery Time	I _{SD} = 9 A, dI _{SD} /dt = 100 A/μs	-	-	74	ns
	Reverse Recovered Charge	I _{SD} = 9 A, dI _{SD} /dt = 100 A/μs	_	1	169	nC

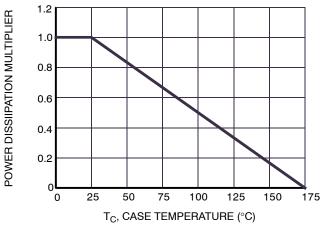
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Starting T_J = 25°C, L = 0.2 mH, I_{AS} = 19 A.

2. Pulse Width = 100 s

TYPICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

D, DRAIN CURRENT (A)



 $V_{GS} = 10 V$ T_C, CASE TEMPERATURE (°C)

Figure 1. Normalized Power Dissipation vs. Ambient Temperature

Figure 2. Maximum Continuous Drain Current vs. Case Temperature

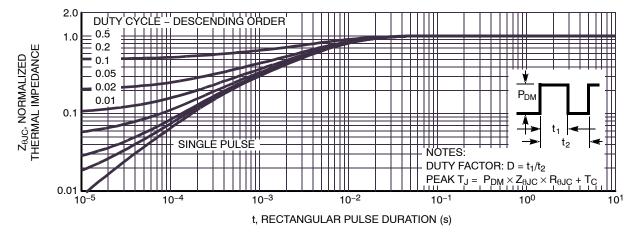


Figure 3. Normalized Maximum Transient Thermal Impedance

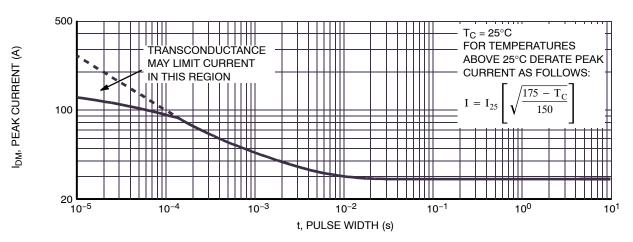


Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted) (continued)

IAS, AVALANCHE CURRENT (A)

DRAIN CURRENT (A)

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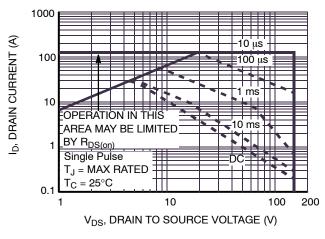


Figure 5. Forward Bias Safe Operating Area

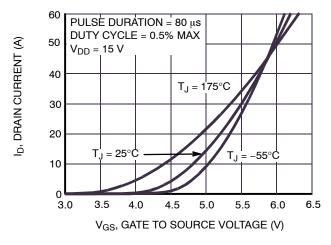


Figure 7. Transfer Characteristics

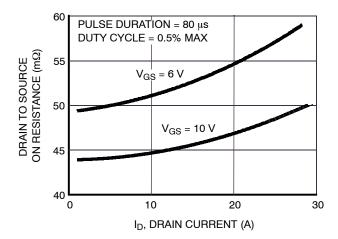
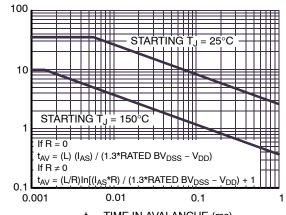


Figure 9. Drain to Source On Resistance vs. Drain Current



t_{AV}, TIME IN AVALANCHE (ms)

NOTE: Refer to **onsemi** Application Notes

AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability

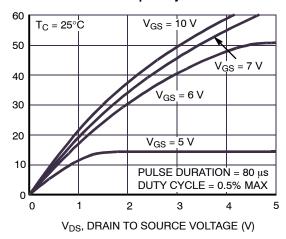


Figure 8. Saturation Characteristics

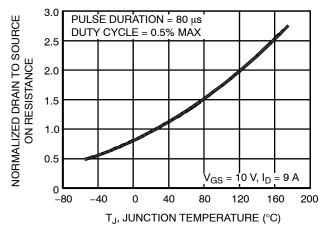


Figure 10. Normalized Drain to Source On Resistance vs. Junction Temperature

$\textbf{TYPICAL CHARACTERISTICS} \ (\textbf{T}_{C} = 25^{\circ} \textbf{C} \ unless \ otherwise \ noted) \ (continued)$

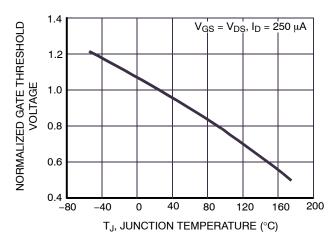


Figure 11. Normalized Gate Threshold Voltage vs. Junction Temperature

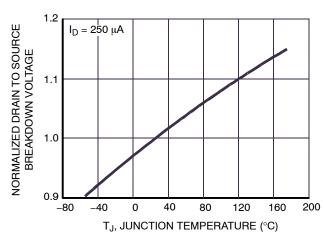


Figure 12. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

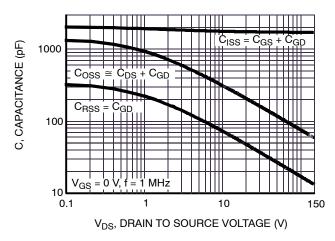


Figure 13. Capacitance vs. Drain to Source Voltage

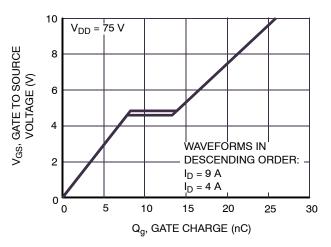


Figure 14. Gate Charge Waveforms for Constant Gate Currents

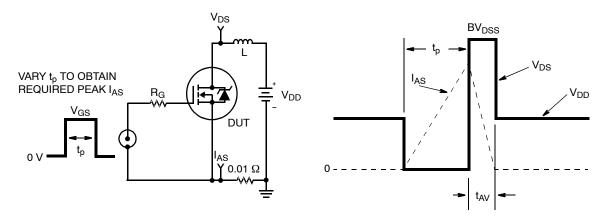


Figure 15. Unclamped Energy Test Circuit

Figure 16. Unclamped Energy Waveforms

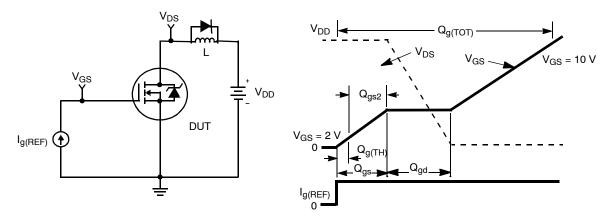


Figure 17. Gate Charge Test Circuit

Figure 18. Gate Charge Waveforms

tOFF

90%

50%

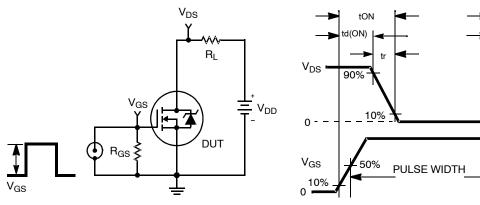


Figure 19. Switching Time Test Circuit

Figure 20. Switching Time Waveforms

PSPICE Electrical Model

```
.SUBCKT FDB2572 2 1 3 ; rev April 2002
CA 12 8 5.5e-10
Cb 15 14 7.4e-10
                                                                                                           LDRAIN
                                                                        DPLCAP
Cin 6 8 1.7e-9
                                                                                                                   DRAIN
                                                                     10
Dbody 7 5 DbodyMOD
                                                                                                           RLDRAIN
                                                                                 ₹RSLC1
Dbreak 5 11 DbreakMOD
                                                                                             DBREAK \
Dplcap 10 5 DplcapMOD
                                                                       RSLC2<sup>₹</sup>
                                                                                    ESLC
                                                                                                   11
Ebreak 11 7 17 18 160
                                                                                  50
Eds 14 8 5 8 1
Egs 13 8 6 8 1
                                                                                 ₹RDRAIN
                                                                                                        DBODY
                                                                                            EBREAK
                                                               ESG
Esg 6 10 6 8 1
                                                                        EVTHRES
Evthres 6 21 19 8 1
                                                                           <u>19</u>
8
                                                                                              MWEAK
                                                 LGATE
                                                              EVTEMP
Evtemp 20 6 18 22 1
                                                        RGATE
                                                                                    MMED
                                                      1 9
It 8 17 1
                                                             20
                                                                             MSTRC
                                                 RLGATE
Lgate 1 9 9.56e-9
                                                                                                           LSOURCE
                                                                             CIN
Ldrain 2 5 1.0e-9
                                                                                                                   SOURCE
                                                                                                                   -o 3
Lsource 3 7 7.71e-9
                                                                                                             AAA
                                                                                             RSOURCE
                                                                                                          RLSOURCE
RLgate 1 9 95.6
                                                                                                 RBREAK
RLdrain 2 5 10
                                                                                              17
                                                                                                         18
RLsource 3 7 77.1
                                                                                                       ≨RVTEMP
                                                                       o SZB
                                                               S1B
Mmed 16 6 8 8 MmedMOD
                                                                             СВ
                                                                                                         19
Mstro 16 6 8 8 MstroMOD
                                                                                            ΙT
                                                                                              (4
                                                                                 14
Mweak 16 21 8 8 MweakMOD
                                                                                                          VBAT
                                                                 EGS
                                                                           EDS
Rbreak 17 18 RbreakMOD 1
                                                                                           8
Rdrain 50 16 RdrainMOD 35e-3
                                                                                                RVTHRES
Rgate 9 20 1.6
RSLC1 5 51 RSLCMOD 1.0e-6
RSLC2 5 50 1.0e3
Rsource 8 7 RsourceMOD 3.0e-3
Rvthres 22 8 RvthresMOD 1
Rvtemp 18 19 RvtempMOD 1
Sla 6 12 13 8 S1AMOD
S1b 13 12 13 8 S1BMOD
S2a 6 15 14 13 S2AMOD
S2b 13 15 14 13 S2BMOD
Vbat 22 19 DC 1
ESLC 51 50 VALUE={(V(5,51)/ABS(V(5,51)))*(PWR(V(5,51)/(1e-6*52),3))}
.MODEL DbodyMOD D (IS=6.0E-11 N=1.14 RS=3.9e-3 TRS1=3.5e-3 TRS2=3.0e-6
+ CJO=1.1e-9 M=0.63 TT=6.2e-8 XTI=4.5)
.MODEL DbreakMOD D (RS=10 TRS1=5.0e-3 TRS2=-5.0e-6)
.MODEL DplcapMOD D (CJO=3.5e-10 IS=1.0e-30 N=10 M=0.65)
.MODEL MmedMOD NMOS (VTO=3.55 KP=3 IS=1e-40 N=10 TOX=1 L=1u W=1u RG=1.6)
.MODEL MstroMOD NMOS (VTO=4.0 KP=25 IS=1e-30 N=10 TOX=1 L=1u W=1u)
.MODEL MweakMOD NMOS (VTO=2.95 KP=0.05 IS=1e-30 N=10 TOX=1 L=1u W=1u RG=16 RS=0.1)
.MODEL RbreakMOD RES (TC1=1.15e-3 TC2=-9.5e-7)
.MODEL RdrainMOD RES (TC1=9.0e-3 TC2=2.5e-5)
.MODEL RSLCMOD RES (TC1=3.0e-3 TC2=2.5e-6)
.MODEL RSourceMOD RES (TC1=4.0e-3 TC2=1.0e-6)
.MODEL RvthresMOD RES (TC1=-4.1e-3 TC2=-1.0e-5)
.MODEL RvtempMOD RES (TC1=-4.0e-3 TC2=1.0e-6)
.MODEL S1AMOD VSWITCH (RON=1e-5 ROFF=0.1 VON=-5.0 VOFF=-3.5)
.MODEL S1BMOD VSWITCH (RON=1e-5 ROFF=0.1 VON=-3.5 VOFF=-5.0)
.MODEL S2AMOD VSWITCH (RON=1e-5 ROFF=0.1 VON=-0.5 VOFF=0.3)
.MODEL S2BMOD VSWITCH (RON=1e-5 ROFF=0.1 VON=0.3 VOFF=-0.5)
.ENDS
```

NOTE: For further discussion of the PSPICE model, consult *A New PSPICE Sub-Circuit for the Power MOSFET Featuring Global Temperature Options*; IEEE Power Electronics Specialist Conference Records, 1991, written by William J. Hepp and C. Frank Wheatley.

SABER Electrical Model

```
REV April 2002
ttemplate FDB2572 n2,n1,n3
electrical n2,n1,n3
var i iscl
\texttt{dp..model dbodymod = (isl=6.0e-11, nl=1.14, rs=3.9e-3, trs1=3.5e-3, trs2=3.0e-6, cjo=1.1e-9, m=0.63, tt=6.2e-8, xti=4.5)}
dp..model dbreakmod = (rs=10,trs1=5.0e-3,trs2=-5.0e-6)
dp..model dplcapmod = (cjo=3.5e-10,isl=10.0e-30,nl=10,m=0.65)
m..model mmedmod = (type= n, vto=3.55, kp=3, is=1e-40, tox=1)
m..model mstrongmod = (type=_n, vto=4.0, kp=25, is=1e-30, tox=1)
m..model mweakmod = (type= n,vto=2.95,kp=0.05,is=1e-30, tox=1,rs=0.1)
                                                                                                             LDRAIN
sw vcsp..model s1bmod = (ron=1e-5, roff=0.1, von=-3.5, voff=-5.0)
                                                                         DPI CAP
                                                                                                                     DRAIN
sw vcsp..model s2amod = (ron=1e-5, roff=0.1, von=-0.5, voff=0.3)
                                                                       10
sw vcsp..model s2bmod = (ron=1e-5, roff=0.1, von=0.3, voff=-0.5)
                                                                                                            RLDRAIN
                                                                                  ≹RSLC1
c.ca n12 n8 = 5.5e-10
                                                                                   51
c.cb n15 \ n14 = 7.4e-10
                                                                        BSI C2 ≨
c.cin n6 n8 = 1.7e-9
                                                                                 (₩) ISCL
                                                                                              DBREAK
                                                                                   50
dp.dbody n7 n5 = model=dbodymod
dp.dbreak n5 n11 = model=dbreakmod
                                                                                  ₹RDRAIN
                                                                ESG(
                                                                                                    11
dp.dplcap n10 n5 = model=dplcapmod
                                                                                                           DBODY
                                                                          EVTHRES
                                                                            \frac{19}{8}
                                                                                            ← MWEAK
spe.ebreak n11 n7 n17 n18 = 160
                                                               EVTEME
                                                 LGATE
                                                         RGATE
spe.eds n14 \ n8 \ n5 \ n8 = 1
                                                                 18
22
                                                                                               EBREAK
                                                                                     MMED
spe.egs n13 n8 n6 n8 = 1
                                                              20
                                                                              MSTRO
spe.esg n6 n10 n6 n8 = 1
                                                 RLGATE
                                                                                                            LSOURCE
spe.evthres n6 n21 n19 n8 = 1
                                                                              CIN
                                                                                                                    SOURCE
                                                                                      8
                                                                                                              ______
spe.evtemp n20 n6 n18 n22 = 1
                                                                                             RSOURCE
                                                                                                           RLSOURCE
i.it n8 \ n17 = 1
                                                                                                  RBREAK
                                                                  <u>13</u>
8
1.1gate n1 n9 = 9.56e-9
                                                                                               17
                                                                                                          18
1.1drain n2 n5 = 1.0e-9
                                                                                                         ≨ RVTEMP
1.1source n3 n7 = 7.71e-9
                                                                              CB
                                                                                                           19
                                                                                              ΙT
                                                                                   14
res.rlgate n1 n9 = 95.6
                                                                                                            VBAT
res.rldrain n2 n5 = 10
                                                                  FGS
                                                                           FDS
res.rlsource n3 n7 = 77.1
                                                                                            8
m.mmed n16 n6 n8 n8 = model=mmedmod, l=1u, w=1u
                                                                                                          22
m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u
                                                                                                  RVTHRES
m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u
res.rbreak n17 n18 = 1, tc1=1.15e-3, tc2=-9.5e-7
res.rdrain n50 n16 = 35e-3, tc1=9.0e-3, tc2=2.5e-5
res.rgate n9 n20 = 1.6
res.rslc1 n5 n51 = 1.0e-6, tc1=3.0e-3, tc2=2.5e-6
res.rslc2 n5 n50 = 1.0e3
res.rsource n8 n7 = 3.0e-3, tc1=4.0e-3, tc2=1.0e-6
res.rvthres n22 n8 = 1, tc1=-4.1e-3, tc2=-1.0e-5
res.rvtemp n18 n19 = 1, tc1=-4.0e-3, tc2=1.0e-6
sw_vcsp.sla n6 n12 n13 n8 = model=slamod
sw vcsp.s1b n13 n12 n13 n8 = model=s1bmod
sw vcsp.s2a n6 n15 n14 n13 = model=s2amod
sw vcsp.s2b n13 n15 n14 n13 = model=s2bmod
v.vbat n22 n19 = dc=1
equations {
i (n51->n50) +=isc1
iscl: v(n51,n50) = ((v(n5,n51)/(1e-9+abs(v(n5,n51))))*((abs(v(n5,n51)*1e6/52))** 3))}
```

SABER Electrical Model

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REV 26 April 2002

FDB2572

CTHERM1 TH 6 3.8e-3

CTHERM2 6 5 4.0e-3

CTHERM3 5 4 4.2e-3

CTHERM4 4 3 4.3e-3

CTHERM5 3 2 8.5e-3

CTHERM6 2 TL 3.0e-2

RTHERM1 TH 6 5.5e-4

RTHERM2 6 5 5.0e-3

RTHERM3 5 4 4.5e-2

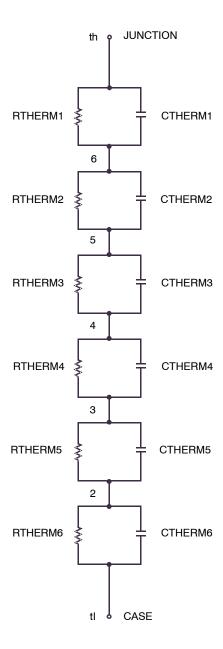
RTHERM4 4 3 10.5e-2

RTHERM5 3 2 3.7e-1

RTHERM5 2 TL 3.8e-1
```

SABER Thermal Model

```
SABER thermal model FDB2572
template thermal_model th t1
thermal_c th, t1
{
ctherm.ctherm1 th 6 =3.8e-3
ctherm.ctherm2 6 5 =4.0e-3
ctherm.ctherm3 5 4 =4.2e-3
ctherm.ctherm4 4 3 =4.3e-3
ctherm.ctherm5 3 2 =8.5e-3
ctherm.ctherm6 2 t1 =3.0e-2
rtherm.rtherm1 th 6 =5.5e-4
rtherm.rtherm2 6 5 =5.0e-3
rtherm.rtherm3 5 4 =4.5e-2
rtherm.rtherm4 4 3 =10.5e-2
rtherm.rtherm5 3 2 =3.7e-1
rtherm.rtherm6 2 t1 =3.8e-1
```



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TO-220-3LD CASE 340AT ISSUE B

DATE 08 AUG 2022



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